

VUSA004R450NA

Datasheet





45mΩ, 40V, N-Channel Power MOSFET

VUSA004R450NA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
40V	45mΩ@10V	5 1
	55mΩ@4.5V) JA

Symbol

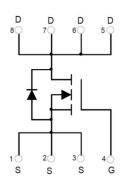


Figure 1 Symbol of VUSA004R450NA

Features

- Trench Technology Power MOSFET
- Low R_{DS(ON)}
- Low Gate Charge

Application

- Load Switch
- Power Switch Application

Package Type



Figure 2 Package Type of VUSA004R450NA

Ordering Information

Product Name	Package		
VUSA004R450NA	SOP8		



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Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current ^{Note1} T _A = 25 °C	I_D	5	Δ.
Pulsed Drain Current Note2	I_{DM}	20	A
Total Power Dissipation ^{Note4} $T_A = 25$ °C	P _D	2	W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	<mark>M</mark> in	T <mark>y</mark> p	Max	Unit	
Thermal Resistance, Junction-to-Ambient Note5			6 <mark>2.</mark> 5		°C/W	





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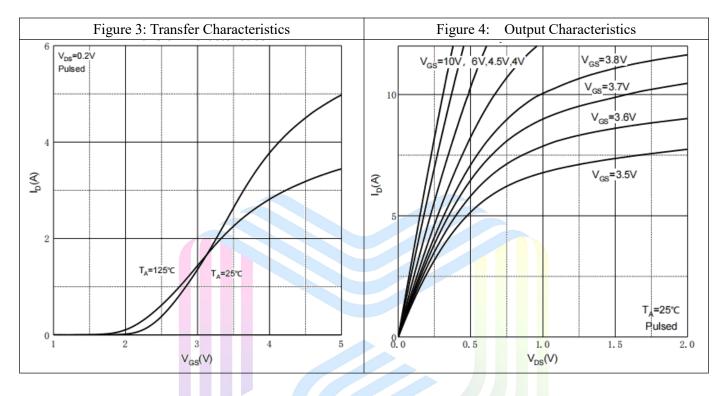
Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

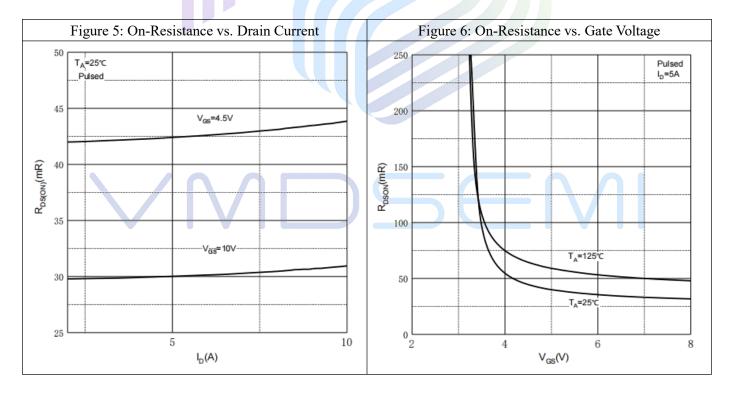
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V _{GS} =0V, I _D = 250uA	40			V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40V, V_{GS} =0V			1	uA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Gate Threshold Voltage ^{Note3}	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1	1.6	2.5	V
Static Drain-Source On-Resistance ^{Note3}	D	$V_{GS}=10V$, $I_D=5A$		28	45	mΩ
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D = 5A		44	55	
Forward Transconductance ^{Note3}	gfs	$V_{DS}=5V$, $I_D=5A$		22		S
Dynamic Characteristics						
Input Capacitance	C _{ISS}	V _{DS} =20V		367		pF
Output Capacitance	Coss	V _{GS} =0V		51		pF
Reverse Transfer Capacitance	C _{RSS}	f=1MHz		41		pF
Total Gate Charge	Qg	V _{DS} =20V		9.3		
Gate-Source Charge	Q_{gs}	V _{GS} =10V		2.1		пC
Gate-Drain Charge	Q_{gd}	$I_D=5A$		1.9		
Gate Resistance	Rg	f = 1MHz, Open drain		1.4		Ω
Switching Parameters						
Turn-on Delay Time	t _{d(on)}	$V_{DD}=15V$		4.5		
Turn-on Rise Time	t _r	$V_{GS}=10V$		2.4		
Turn-off Delay Time	$t_{ m d(off)}$	$R_L=2.6\Omega$		14.8		ns
Turn-off Fall Time	t_{f}	$R_G=3\Omega$		2.5		
Diode Characteristics						
Diode Forward Voltage Note3	V_{SD}	$V_{GS}=0V$, $I_S=1A$			1.2	V

Notes:

- 1. The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2. Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3. Pulse Test : Pulse Width $\leq 300 \mu s$, duty cycle $\leq 2\%$.
- 4. The power dissipation P_D is limited by $T_{J(MAX)} = 150^{\circ}C$. And device mounted on a large heatsink
- 5.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

Typical Performance Characteristics

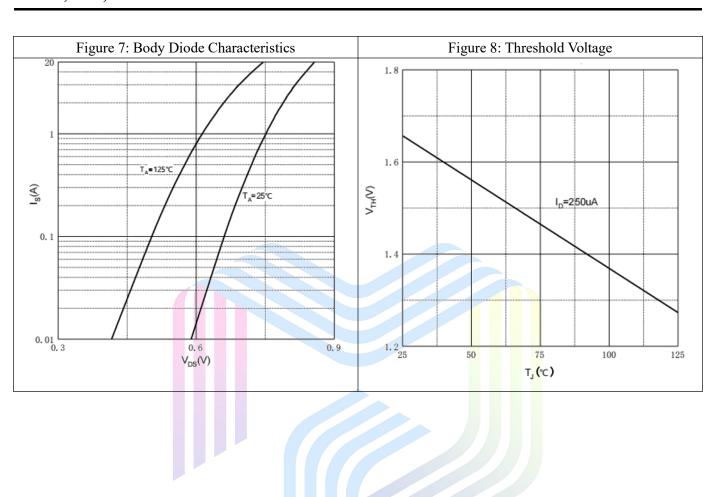






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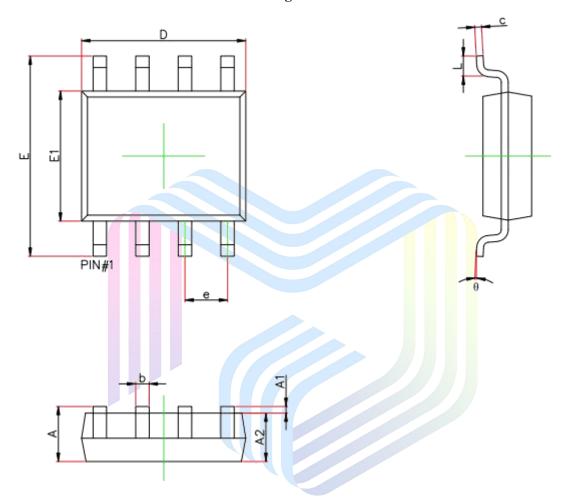




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Mechanical Dimensions:

SOP8 Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.156	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.201	
е	1.270	(BSC)	0.050	(BSC)	
E	5.800	6.200	0.228	0.244	
E1	3.700	4.100	0.146	0.161	
L	0.400	1.270	0.016	0.05	
θ	0°	8°	0°	8°	

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